

$V_{RRM} = 4500 \text{ V}$
 $I_{FAVM} = 900 \text{ A}$
 $I_{FSM} = 16 \text{ kA}$
 $V_{F0} = 1.8 \text{ V}$
 $r_F = 0.9 \text{ m}\Omega$
 $V_{DClink} = 2400 \text{ V}$

Fast Recovery Diode

5SDF 07H4501

Doc. No. 5SYA1111-02 Sep. 01

- Patented free-floating silicon technology
- Low switching losses
- Optimized for use as large-area snubber diode in GTO converters
- Industry standard press-pack ceramic housing, hermetically plasma-welded
- Cosmic radiation withstand rating

Blocking

V_{RRM}	Repetitive peak reverse voltage	4500 V	Half sine wave, $t_p = 10 \text{ ms}$, $f = 50 \text{ Hz}$	
I_{RRM}	Repetitive peak reverse current	$\leq 200 \text{ mA}$	$V_R = V_{RRM}$, $T_J = 125^\circ\text{C}$	
V_{DClink}	Permanent DC voltage for 100 FIT failure rate	2400 V	100% Duty	Ambient cosmic radiation at sea level in open air.
V_{DClink}	Permanent DC voltage for 100 FIT failure rate	2800 V	5% Duty	

Mechanical data (see Fig. 8)

F_m	Mounting force	min.	36 kN	
		max.	44 kN	
a	Acceleration: Device unclamped Device clamped		50 m/s ² 200 m/s ²	
m	Weight		0.83 kg	
D_s	Surface creepage distance	\geq	30 mm	
D_a	Air strike distance	\geq	20 mm	

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On-state (see Fig. 2, 3)

I_{FAVM}	Max. average on-state current	900 A	Half sine wave, $T_c = 85^{\circ}C$	
I_{FRMS}	Max. RMS on-state current	1400 A		
I_{FSM}	Max. peak non-repetitive surge current	16 kA	$t_p = 10\text{ ms}$	Before surge: $T_c = T_j = 125^{\circ}C$
		40 kA	$t_p = 1\text{ ms}$	
$\int I^2 dt$	Max. surge current integral	$1.28 \cdot 10^6\text{ A}^2s$	$t_p = 10\text{ ms}$	After surge: $V_R \approx 0\text{ V}$
		$0.8 \cdot 10^6\text{ A}^2s$	$t_p = 1\text{ ms}$	
V_F	Forward voltage drop	$\leq 4.5\text{ V}$	$I_F = 3000\text{ A}$	$T_j = 125^{\circ}C$
V_{F0}	Threshold voltage	1.8 V	Approximation for	
r_F	Slope resistance	0.9 mΩ	$I_F = 500 \dots 5000\text{ A}$	

Turn-on (see Fig. 4, 5)

V_{fr}	Peak forward recovery voltage	$\leq 55\text{ V}$	$di/dt = 500\text{ A}/\mu s, T_j = 125^{\circ}C$
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Turn-off (see Fig. 6, 7)

I_{rr}	Reverse recovery current	$\leq 260\text{ A}$	$di/dt = 100\text{ A}/\mu s, I_F = 1000\text{ A},$ $T_j = 125^{\circ}C, R_S = 22\Omega, C_S = 0.22\mu F$
Q_{rr}	Reverse recovery charge	$\leq 1700\text{ }\mu C$	

Thermal (see Fig. 1)

T_j	Operating junction temperature range	-40...125°C		
T_{stg}	Storage temperature range	-40...125°C		
R_{thJC}	Thermal resistance junction to case	$\leq 24\text{ K/W}$	Anode side cooled	$F_m = 36 \dots 44\text{ kN}$
		$\leq 24\text{ K/W}$	Cathode side cooled	
		$\leq 12\text{ K/W}$	Double side cooled	
R_{thCH}	Thermal resistance case to heatsink	$\leq 6\text{ K/W}$	Single side cooled	
		$\leq 3\text{ K/W}$	Double side cooled	

Analytical function for transient thermal impedance.

$$Z_{thJC}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i(K/W)$	7.44	2.00	1.84	0.71
$\tau_i(s)$	0.47	0.091	0.011	0.0047
$F_m = 36 \dots 44\text{ kN}$ Double side cooled				

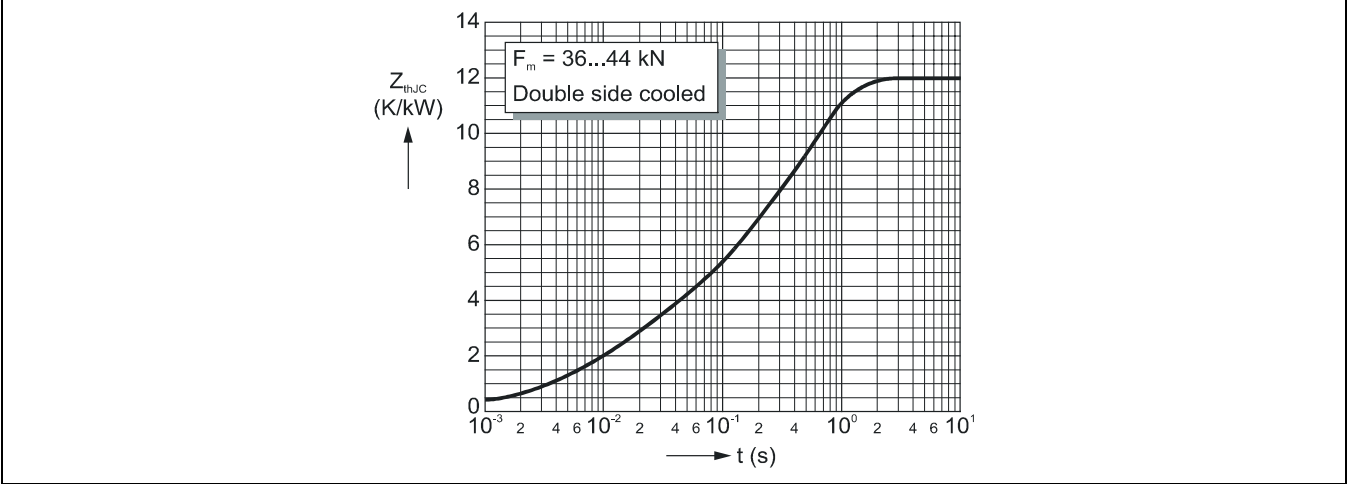


Fig. 1 Transient thermal impedance (junction-to-case) vs. time in analytical and graphical form (max. values).

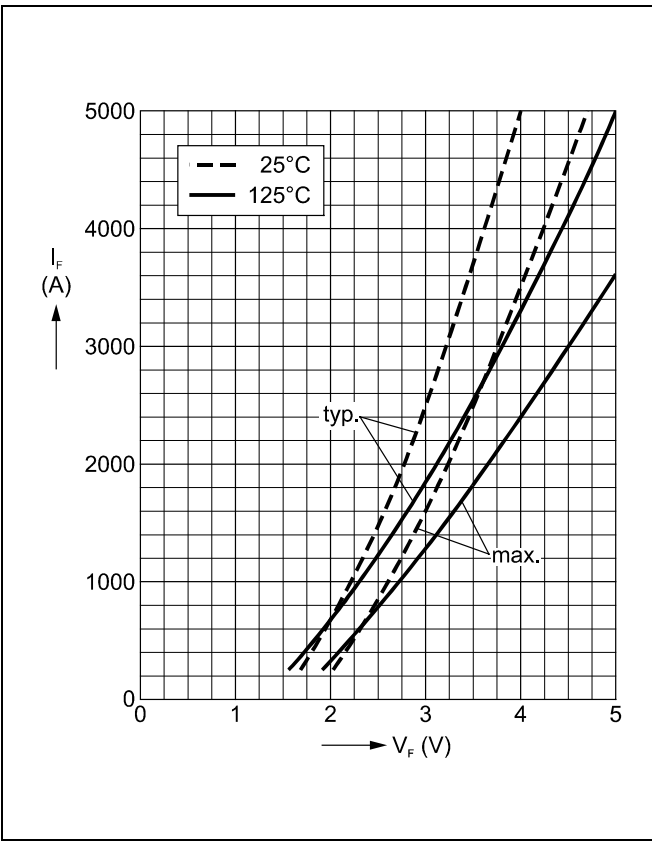


Fig. 2 Forward current vs. forward voltage (typ. and max. values) and linear approximation of max. curve at 125°C .

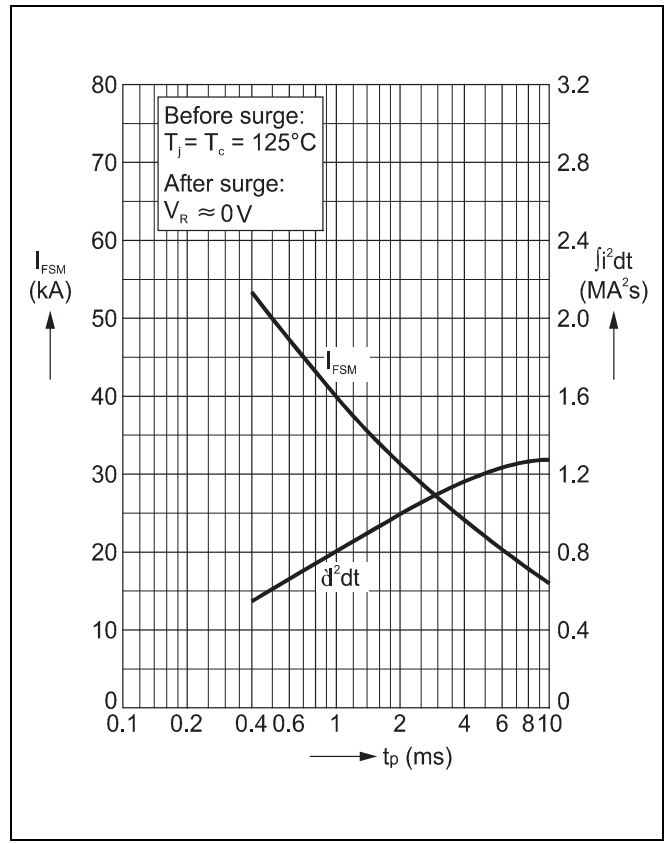


Fig. 3 Surge current and fusing integral vs. pulse width (max. values) for non-repetitive, half-sinusoidal surge current pulses.

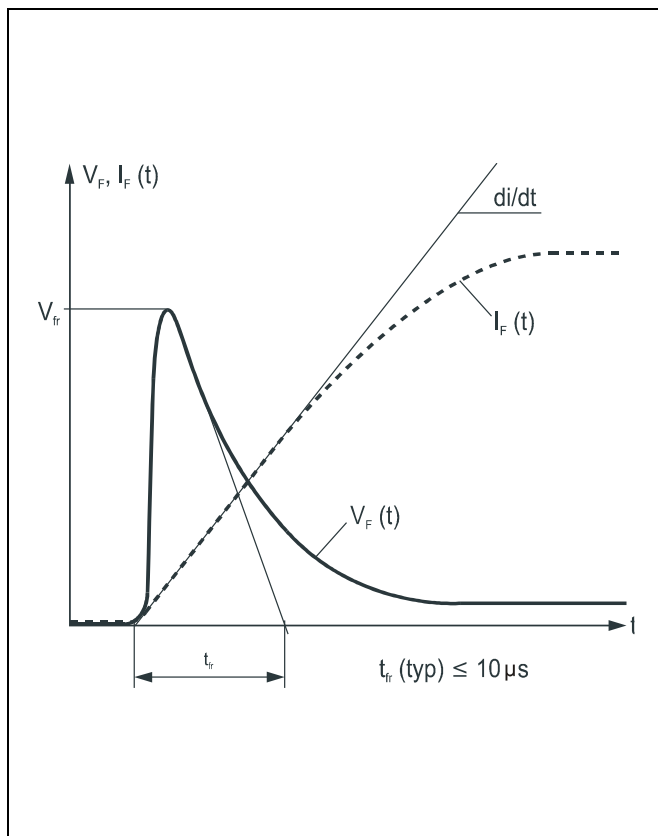


Fig. 4 Typical forward voltage waveform when the diode is turned on with a high di/dt .

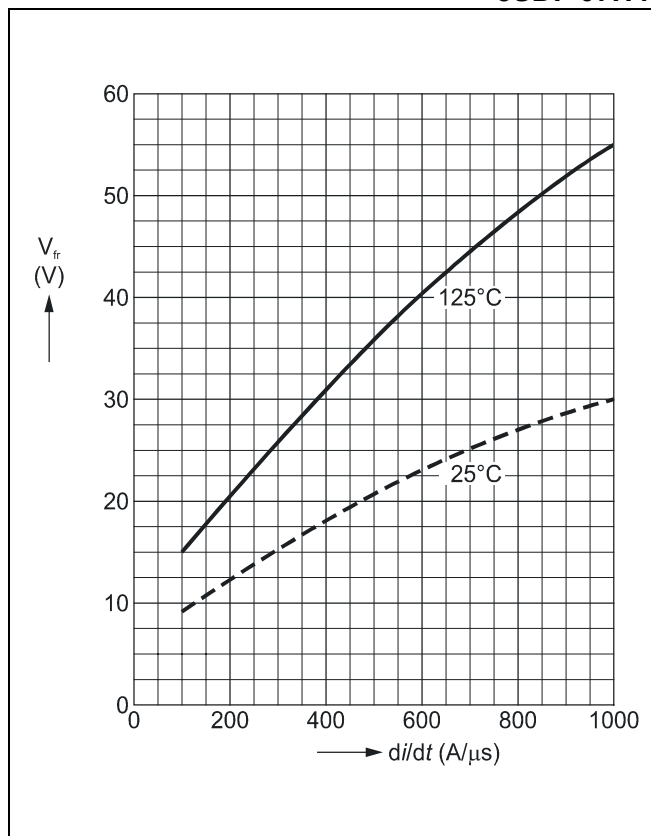


Fig. 5 Forward recovery voltage vs. turn-on di/dt (max. values).

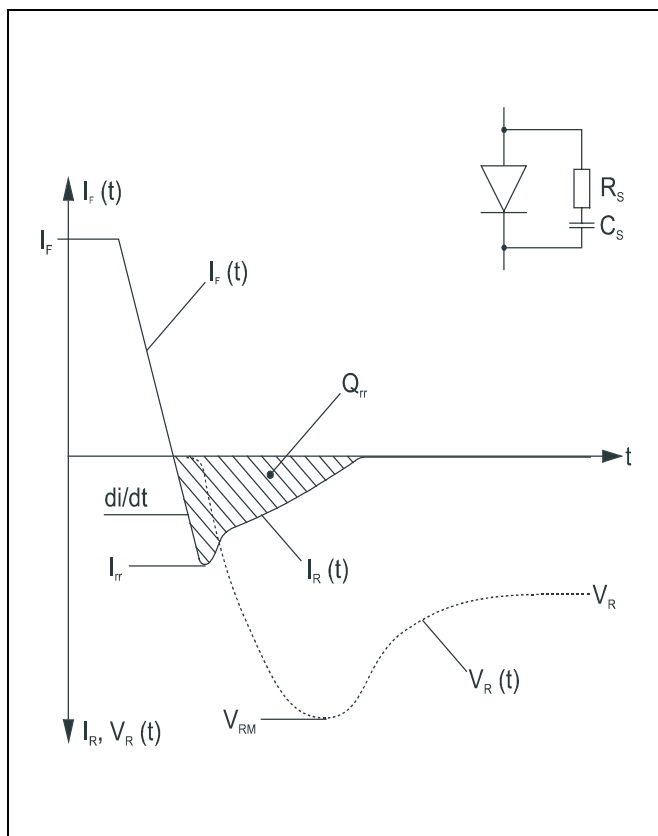


Fig. 6 Typical current and voltage waveforms at turn-off when the diode is connected to an RCD snubber, as often used in GTO circuits.

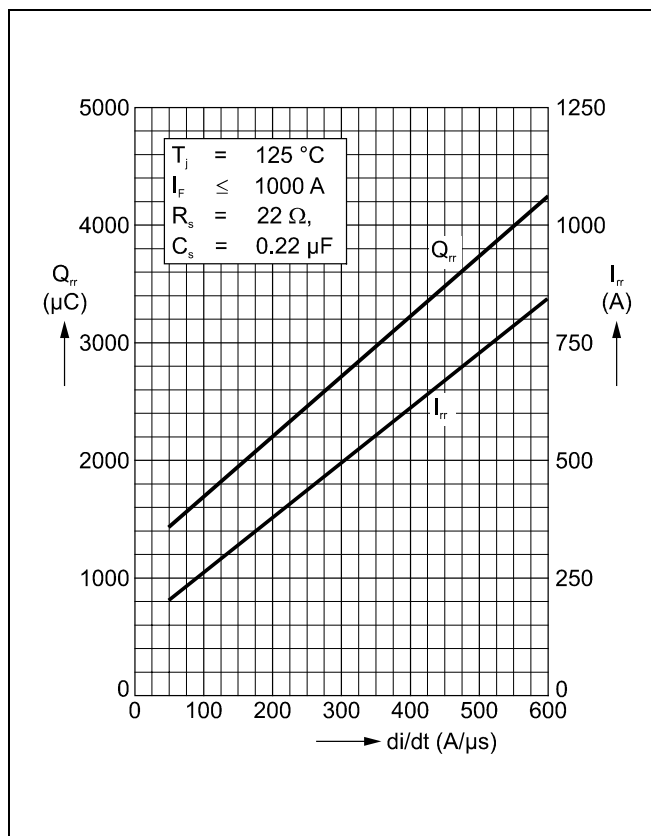


Fig. 7 Reverse recovery current vs. turn off di/dt (max. values).

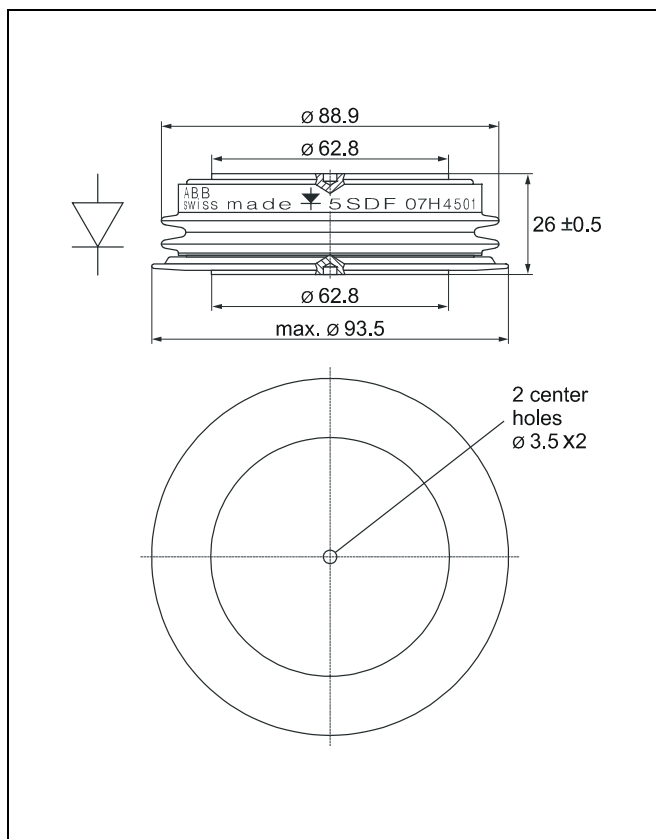


Fig. 8 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

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